3A Ultra Low Dropout Linear Regulator

FEATURES

- Guaranteed 3A Output Current
- Low Ground Current
- 0.5μA Quiescent Current in Shutdown
- Fixed Output Voltage of 1.5V, 1.8V, 2.5V, 3.3V
- Fast Transient Response
- Current Limit and Thermal Limit
- Available in SOT-223, TO-220, TO-263
  TO-263-5, TO-252 and TO-252-5 Packages

APPLICATIONS

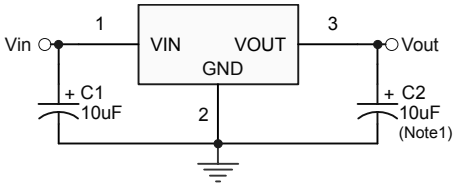
- Mother Board and Notebook
- Gigabit Ethernet Switch
- Microprocessor Power Systems
- Network Cards
- Peripheral Cards
- GTL, GTL+, BTL, and SSTL Bus Terminators
- DSPs Power Supplies
- Battery Powered Applications

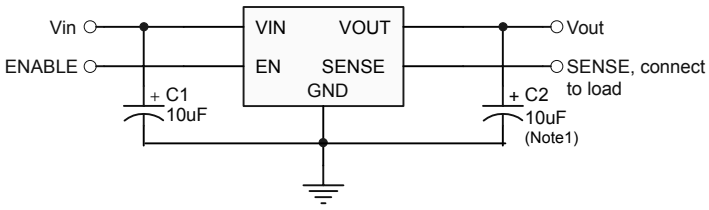
DESCRIPTION

The AIC1185 is an ultra low dropout and high performance linear regulator with 3A output current capability. The output voltage is fixed 1.5V, 1.8V, 2.5V and 3.3V. Its low dropout voltage and fast transient response make it ideal for low voltage microprocessor applications.

In addition, the enable pin reduces power dissipation at shutdown mode. Current limit and thermal protection provide protection against any overload condition that would create excessive junction temperatures.

TYPICAL APPLICATION CIRCUIT





ORDERING INFORMATION

AIC1185-XXXXXX

- PACKING TYPE
  - TR: TAPE & REEL
  - TB: TUBE
- PACKAGING TYPE
  - Y: SOT-223
  - M: TO-263
  - E: TO-252
  - T: TO-220
  - M5: TO-263-5
  - E5: TO-252-5
- C: Commercial
  P: Lead Free Commercial
- OUTPUT VOLTAGE
  - 15: 1.5V
  - 18: 1.8V
  - 25: 2.5V
  - 33: 3.3V

Example: AIC1185-15CYTR

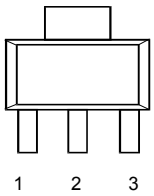
→ 1.5V version in SOT-223 Package & Taping & Reel Packing Type

AIC1185-15PYTR

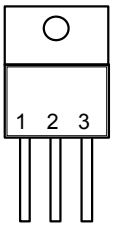
→ 1.5V Version, in SOT-223 Lead Free Package & Tape & Reel Packing Type

PIN CONFIGURATION

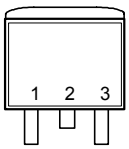
SOT-223
TOP VIEW
1: VIN
2: GND (TAB)
3: VOUT



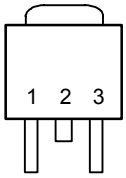
TO-220
FRONT VIEW
1: VIN
2: GND (TAB)
3: VOUT



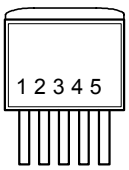
TO-263
TOP VIEW
1: VIN
2: GND (TAB)
3: VOUT



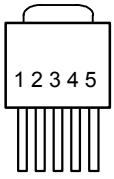
TO-252
TOP VIEW
1: VIN
2: GND (TAB)
3: VOUT



TO-263-5
TOP VIEW
1: VIN
2: EN
3. GND (TAB)
4. SENSE
5: VOUT



TO-252-5
TOP VIEW
1: VIN
2: EN
3. GND (TAB)
4. SENSE
5: VOUT



ABSOLUTE MAXIMUM RATINGS

Supply Voltage……5.5V

Storage Temperature Rang…….-65°C~150°C

Operating Temperature Range ……-40°C~85°C

Junction Temperature…….. 125°C

Lead Temperature (Soldering, 10sec)……260°C

Thermal Resistance (Junction to Case) TO-220…….3°C /W

SOT-223……15°C /W

TO-263, TO-263-5…..…….…….6°C /W

TO-252, TO-252-5…..……..…..……12.5°C /W

Thermal Resistance Junction to Ambient TO-220…….…..……...50°C /W

(Assume no ambient airflow, no heatsink) SOT-223……..……130°C /W

TO-263, TO-263-5……..…….……60°C /W

TO-252, TO-252-5…...……..……100°C /W

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

TEST CIRCUIT

Refer to “TYPICAL APPLICATION CIRCUIT”.

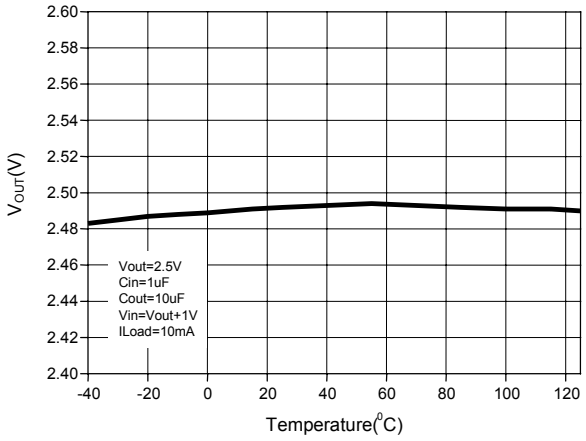
ELECTRICAL CHARACTERISTICS ($V_{IN}=V_O+0.7V$, $I_{OUT}=10mA$, $V_{EN}=V_{IN}$, $T_A=25°C$, unless otherwise specified) (Note 2)

PARAMETER	TEST CONDITIONS		SYMBOL	MIN.	TYP.	MAX.	UNIT
Input Voltage Range			V_{IN}	2.25		5.5	V
Output Voltage Tolerance				-1.5		+1.5	%
Line Regulation	$V_{IN}=V_{OUT}+V_{Drop(max)}$ to 5.5V		ΔV_{LIR}		0.3	1	%
Load Regulation	$V_{IN}=V_{OUT}+0.7$		ΔV_{LOR}		30	60	mV
Dropout Voltage	I_{OUT}=3A	$V_0 \geq 1.8$	V_{DROP}		550	700	mV
		V_0=1.5				750	
Quiescent Current			I_Q		1	2	mA
Shutdown Supply Current	V_{EN}=0V		I_{SD}		0.5	5	μA
Output Current Limit	$V_{IN}=V_{OUT}+0.7$		I_{IL}	3	5		A
Shutdown Terminal Specifications							
EN Pin Shutdown Threshold	Output=H		V_{EN}	1.2			V
	Output=L					0.4	
EN Pin Current	$V_{EN}=V_{IN}$		I_{EN}		0.1		nA
FLG Pin Leakage Current					1		nA
FLG Pin Sink Current	V_{FLG}=0.5V			2			mA
Thermal Protection							
Thermal Shutdown Temperature	Guaranteed by design		T_{SD}		170		ºC
Thermal Shutdown Hysteresis	Guaranteed by design		T_{HYST}		10		ºC

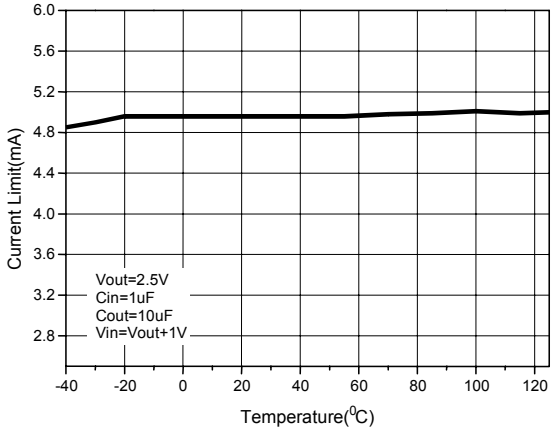
Note 1: To avoid output oscillation, aluminum electrolytic or tantalum output capacitor is recommended and ceramic capacitor is not suggested.

Note 2: Specifications are production tested at T_A =25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

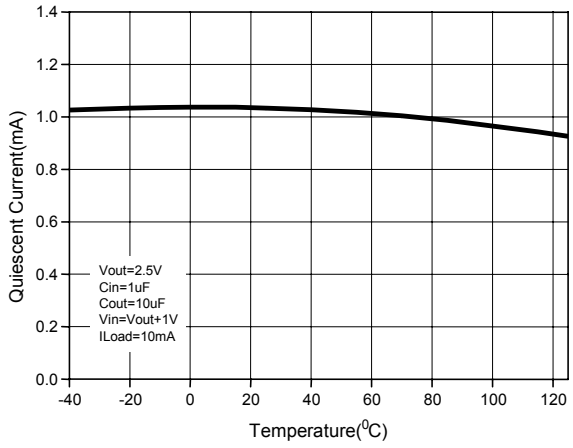
TYPICAL PERFORMANCE CHARACTERISTICS



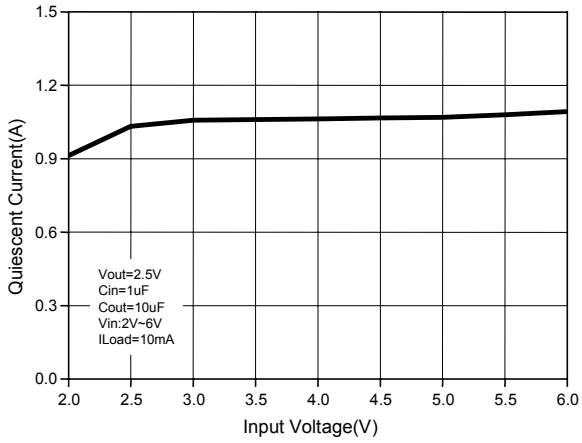
Output Voltage vs. Temperature



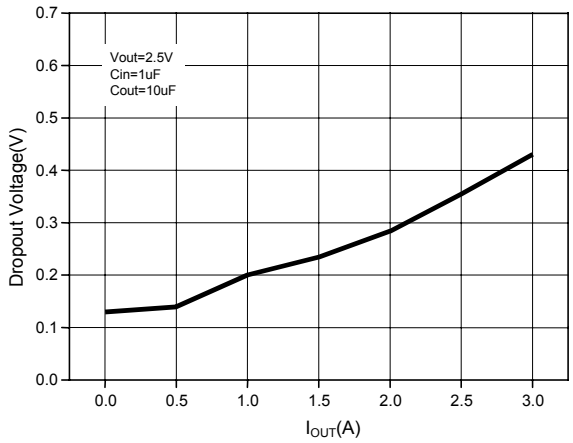
Current Limit vs. Temperature



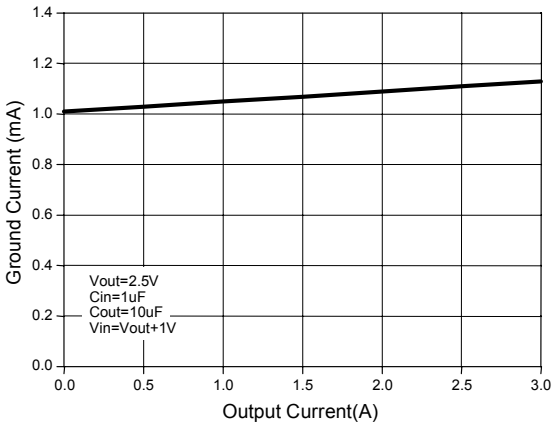
Quiescent Current vs. Temperature



Quiescent Current vs. Input Voltage

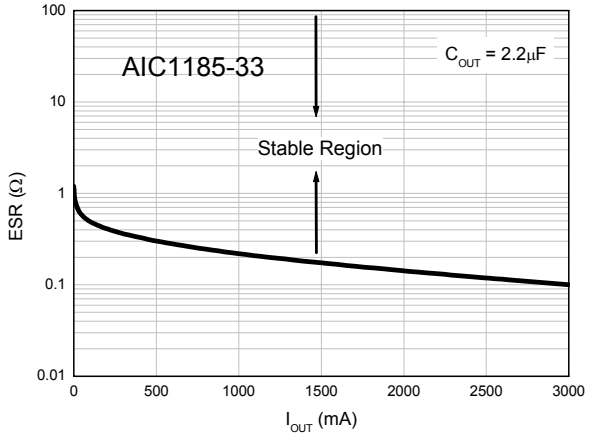


Dropout Voltage vs. Output Current

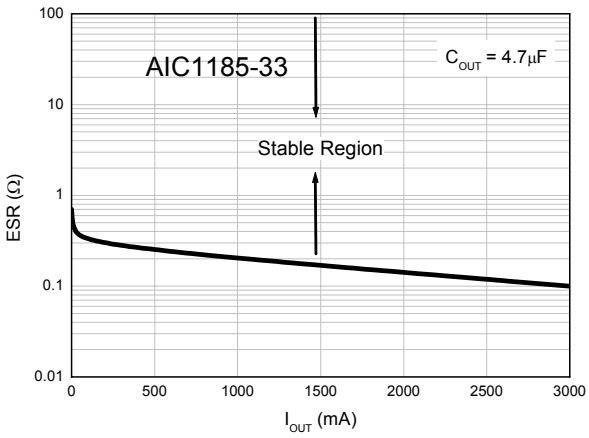


Ground Current vs. I_{OUT} Current

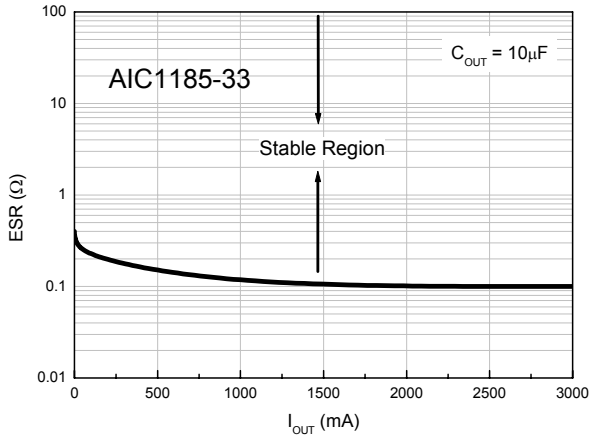
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



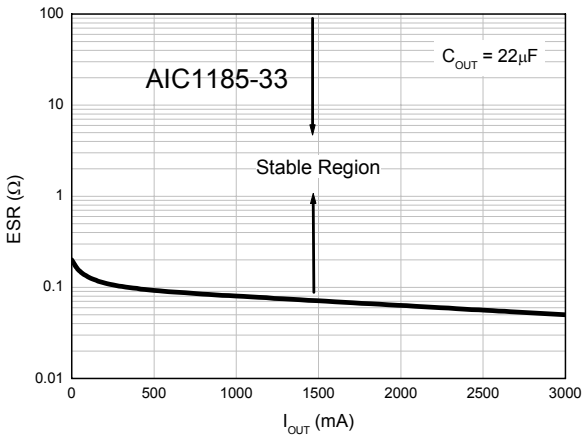
Region of Stable C_{OUT}(2.2uF) ESR vs. Load Current



Region of Stable C_{OUT}(4.7uF) ESR vs. Load Current

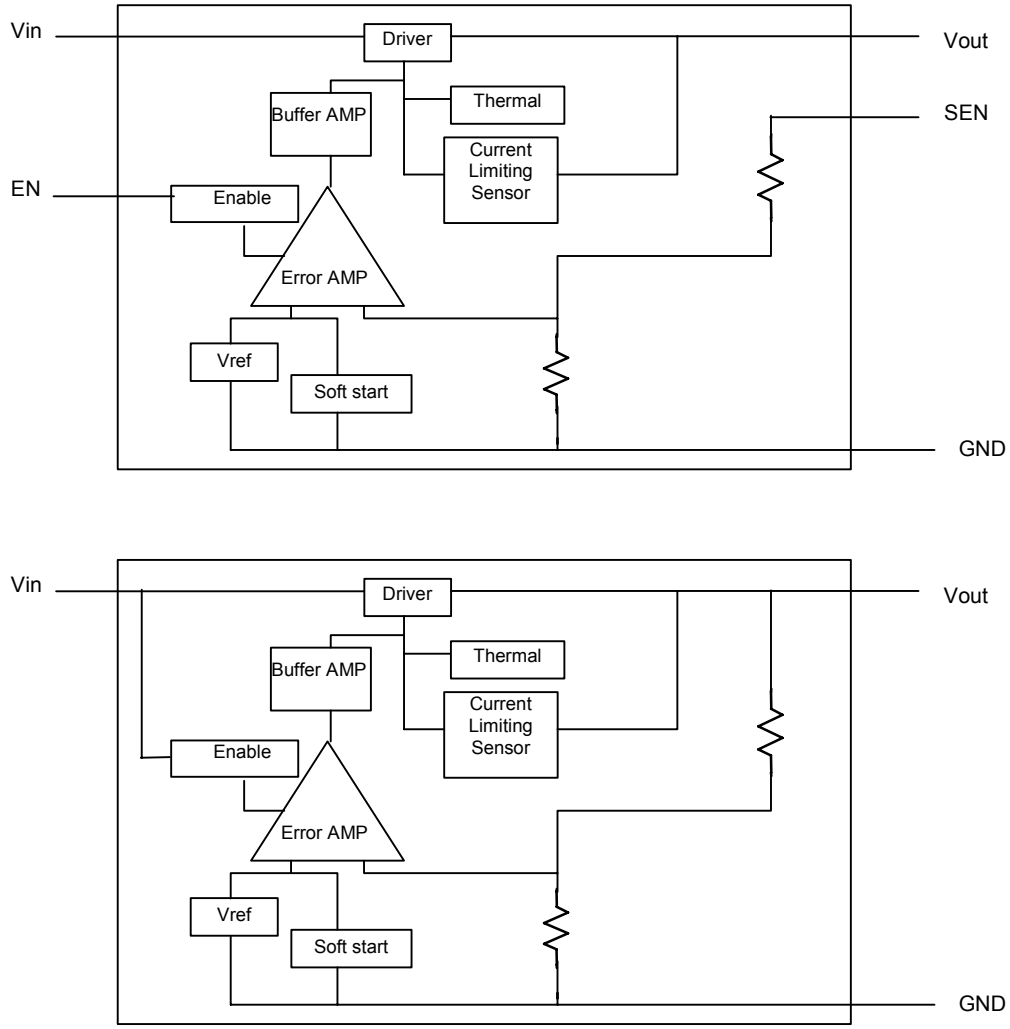


Region of Stable C_{OUT}(10uF) ESR vs. Load Current



Region of Stable C_{OUT}(22uF) ESR vs. Load Current

BLOCK DIAGRAM



PIN DESCRIPTIONS

VOUT PIN - Output voltage.
GND PIN - Power GND.
SEN PIN - Remote sense.
VIN PIN - Power Input.
EN PIN - Enable Input.

APPLICATION INFORMATIONS

Input/Output Capacitors

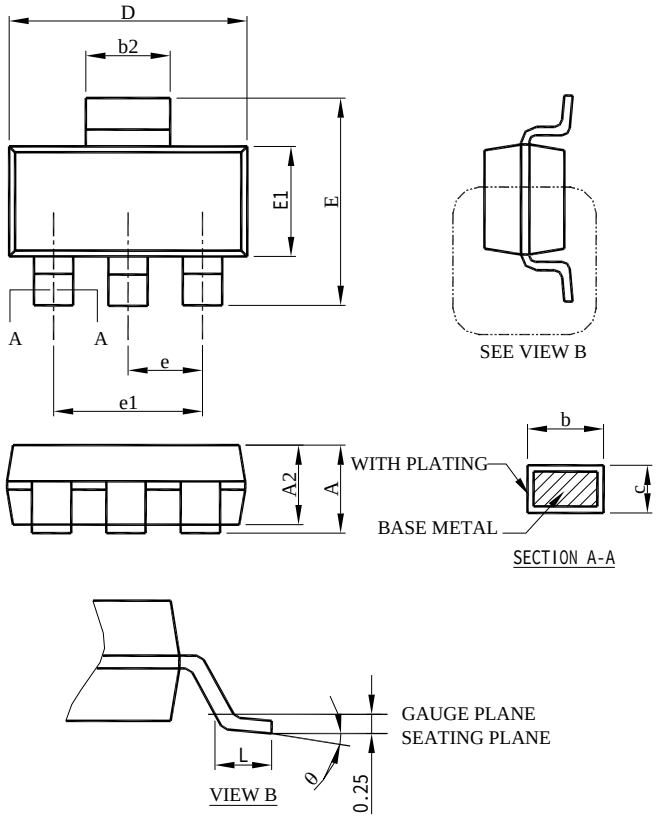
Linear regulators require input and output capacitors to maintain stability. A 4.7μF or 10μF electrolytic or tantalum output capacitor is recommended. To avoid oscillation, it is recommended to follow the figures of "Region of Stable C_{OUT} ESR vs. Load Current" to choose proper capacitor specifications.

Sense

Load is not usually close to regulator in actual application. The distance between these two devices results in decay of the load. A SENSE pin of the regulator connects to the load and traces the load voltage. AIC1185 will adjust the output voltage of the regulator to maintain the load at expected voltage.

PHYSICAL DIMENSIONS

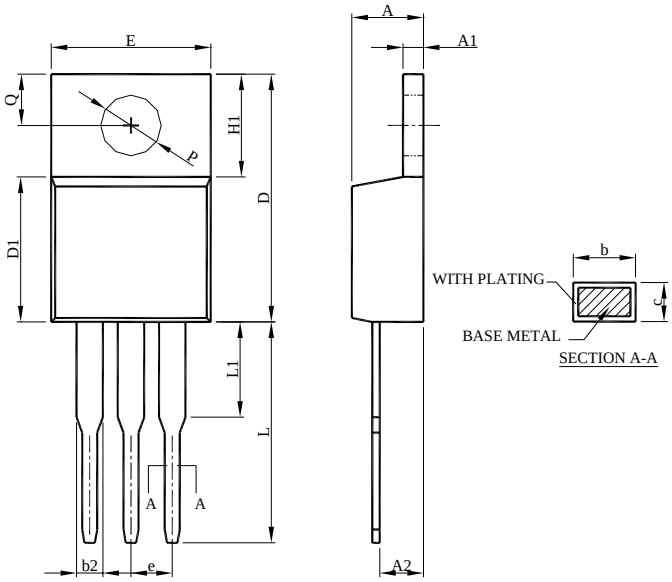
- **SOT-223**



SYMBOL	SOT-223	
	MILLIMETERS	
	MIN.	MAX.
A		1.80
A1	0.02	0.10
A2	1.55	1.65
b	0.66	0.84
b2	2.90	3.10
c	0.23	0.33
D	6.30	6.70
E	6.70	7.30
E1	3.30	3.70
e	2.30 BSC	
e1	4.60 BSC	
L	0.90	
θ	0°	8°

Note:
1.Refer to JEDEC TO-261AA.
2.Dimension D and E1 are determined at the outermost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs, and interlead flash, but including any mismatch between the top and bottom of the plastic body.
3.Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

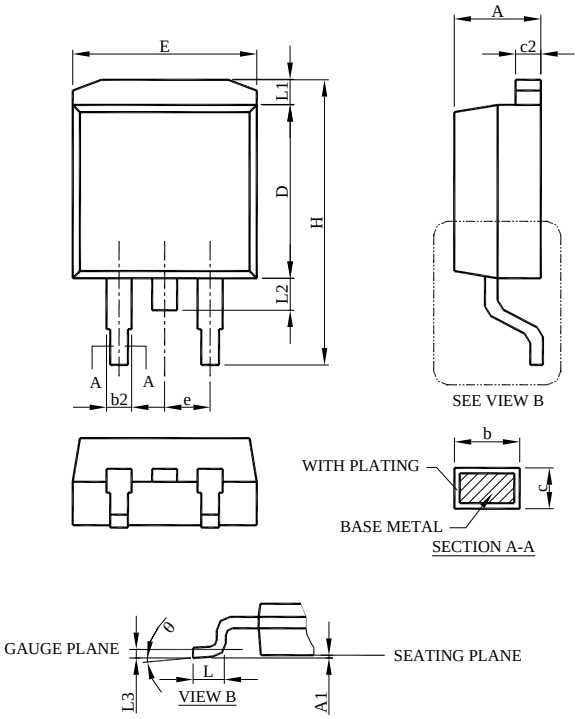
- **TO-220**



SYMBOL	TO-220	
	MILLIMETERS	
	MIN.	MAX.
A	3.56	4.82
A1	0.51	1.39
A2	2.04	2.92
b	0.38	1.01
b2	1.15	1.77
c	0.35	0.61
D	14.23	16.51
D1	8.38	9.02
E	9.66	10.66
e	2.54 BSC	
H1	5.85	6.85
L	12.70	14.73
L1	--	6.35
P	3.54	4.08
Q	2.54	3.42

Note:
1.Refer to JEDEC TO-220AB.
2.Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

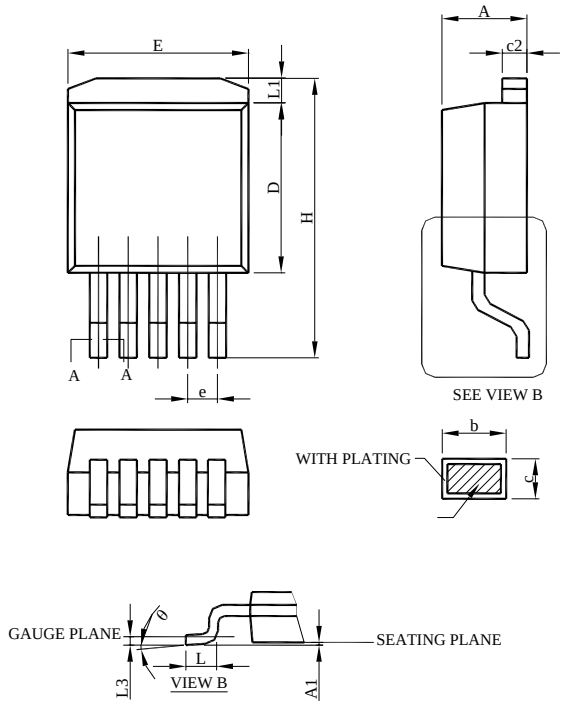
- **TO-263**



SYMBOL	TO-263-3L	
	MILLIMETERS	
	MIN.	MAX.
A	4.06	4.83
A1	0.00	0.25
b	0.51	0.99
b2	1.14	1.78
c	0.38	0.74
c2	1.14	1.65
D	8.38	9.65
E	9.65	10.67
e	2.54 BSC	
H	14.61	15.88
L	1.78	2.79
L1	--	1.68
L2	--	1.78
L3	0.25 BSC	
θ	0°	8°

Note:
1.Refer to JEDEC TO-263AB.
2.Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

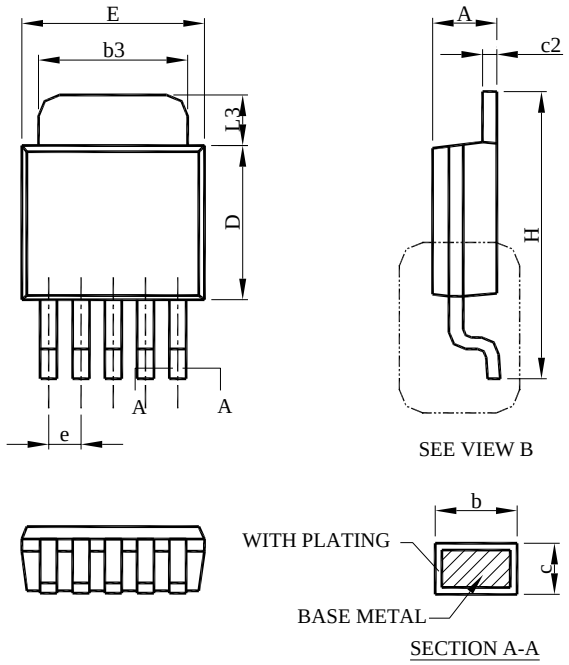
- **TO-263-5**



SYMBOL	TO-263-5L	
	MILLIMETERS	
	MIN.	MAX.
A	4.06	4.83
A1	0.00	0.25
b	0.51	0.99
c	0.38	0.74
c2	1.14	1.65
D	8.38	9.65
E	9.65	10.67
e	1.70 BSC	
H	14.61	15.88
L	1.78	2.79
L1	--	1.68
L3	0.25 BSC	
θ	0°	8°

Note:
1.Refer to JEDEC TO-263AB.
2.Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

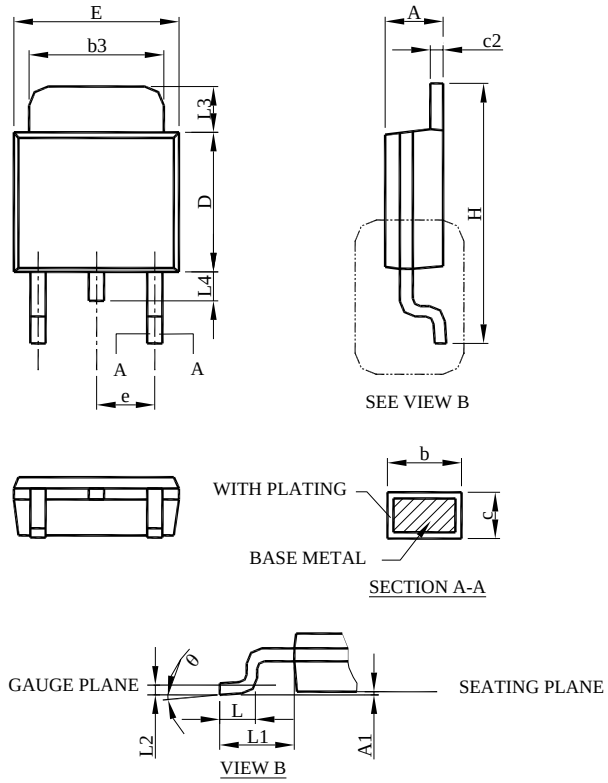
- **TO-252-5**



SYMBOL	TO-252-5L	
	MILLIMETERS	
	MIN.	MAX.
A	2.19	2.38
A1	0.00	0.13
b	0.51	0.71
b3	4.32	5.46
c	0.46	0.61
c2	0.46	0.89
D	5.33	6.22
E	6.35	6.73
e	1.27 BSC	
H	9.40	10.41
L	1.40	1.78
L1	2.67 REF	
L2	0.51 BSC	
L3	0.89	2.03
θ	0°	8°

Note:
1.Refer to JEDEC TO-252AD and AB.
2.Dimension D and E do not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
3.Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

- **TO-252**



SYMBOL	TO-252-3L	
	MILLIMETERS	
	MIN.	MAX.
A	2.19	2.38
A1	0.00	0.13
b	0.64	0.89
b3	4.95	5.46
c	0.46	0.61
c2	0.46	0.89
D	5.33	6.22
E	6.35	6.73
e	2.28 BSC	
H	9.40	10.41
L	1.40	1.78
L1	2.67 REF	
L2	0.51 BSC	
L3	0.89	2.03
L4	--	1.02
θ	0°	8°

Note:
1.Refer to JEDEC TO-252AA and AB.
2.Dimension D and E do not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
3.Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

Note: